

Lead free compatible Tg180 high thermal reliability for Lead free compatible laminate and prepreg

TU-752, TU-75P

TU-752 laminates are made of high quality woven E-glass coated with the epoxy resin system, which provides the laminates with UV-block characteristic, and compatibility with automated optical inspection (AOI) process. These products are suitable for boards that need to survive severe thermal cycles, or to experience excessive assembly work. TU-752 laminates exhibit excellent CTE, superior chemical resistance thermal stability and anti-CAF resistance.

PERFORMANCE AND PROCESSING ADVANTAGES

- Lead Free compatible
- Excellent coefficient of thermal expansion
- Excellent anti-CAF capability
- Superior chemical and thermal resistance
- Fluorescence for AOI
- Optical characteristics provide UV-block property
- High interlayer bonding strength with optimum resin flow
- Low moisture absorption

GENERAL INFORMATION

•	Industry Approvals	
	IPC-4101 Type Designation	/99, /101, /126
	UL Designation – ANSI Grade	FR-4
	UL File Number	E189572
	Flammability Rating	94V-0
	Maximum Operating Temperature	130°C

• Standard Availability

Thickness: 0.002"[0.05mm] to 0.062"[1.58mm], available in sheet or panel form Copper Foil Cladding: 1/8 to 6oz (HTE) for built-up; 1/8 to 3oz (HTE) for double sides and H to 2oz (MLS) Prepregs: Available in roll or panel form Glass Styles: 106, 1080, 2113, 2116, 1506 and 7628, etc.



TYPICAL PROPERTY VALUES FOR TU-752 LAMINATES

PROPERTY	IPC-4101	SPEC	TYPICAL VALUES
Thermal			
Tg (DMA)			190 ℃
Tg (DSC)	E 2/10E doc	NI / A	180 °C
Tg (TMA)	E-2/105+des	N/A	170 °C
Td (TGA)			350 °C
CTE x-axis	Ambient to Tg	-	11~15 ppm/°C
CTE y-axis	Ambient to Tg	-	11~15 ppm/°C
CTE z-axis	25 to 260°C	_	2.7 %
Thermal Stress,		10	
Solder Float , 288°C	A	> 10	> 60 sec
T-260	E-2/105+des	N/A	> 60 min
T-288			> 15 min
Flammability	E-24/125+des	94V-0	94V-0
Electrical			
Permittivity (RC 50%)			
1MHz	C-24/23/50	< 5.4	4.6
1GHz	C-24/23/50	_	4.3
Loss Tangent (RC 50%)	- 1 - 1 - 1		-
1MHz	C-24/23/50	< 0.035	0.014
1GHz	C-24/23/50	- 0.000	0.013
Volume Resistivity	C-96/35/90	> 106	> 10 ¹⁰ MΩ · cm
Surface Resistivity	C-96/35/90	> 104	> 10 ⁸ MΩ
Electric Strength		>30 kV/mm	> 40 kV/mm
Dielectric Breakdown Voltage		>40 kV	> 50 kV
Physical			
Peel Strength, 1.0 oz. Cu foil	А	> 6	7~9 lb/inch
Flexural Strength			
Lengthwise	А	> 60,000	> 65,000 psi
Crosswise	Α	> 50,000	> 55,000 psi
Bow and Twist			
0.020"~0.031"		Max 1.5	< 0.8 %
0.032:~0.065:		Max 1.0	< 0.8 %
>0.066"		Max 1.0	< 0.8 %
Dimensional Stability	E-4/105+E-2/150	< 0.03	< 0.03 %

NOTE:

1. The above testing results are based on 1.0mm (0.039") laminates.

2. Property values are for information purposes only and are not guaranteed.

3.Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.